





Products

Industries

Resources

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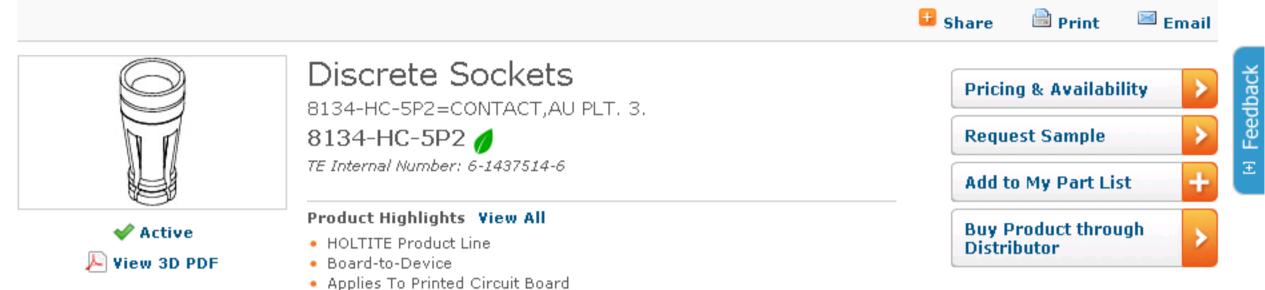
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Innovation

Support Center

Home > Products > Socket/Card Products > Product Feature Selector > Product Details

8134-HC-5P2 Product Details



 Mating Pin Dia. Range = .28 - .46 mm, .406 - .533 mm Documents Compliance Features Please Note: Use the Product Drawing for all design activity Product Type Features **Industry Standards** Government/Industry **Product Line** HOLTITE No Qualification Sealant 🛭 Without RoHS/ELV Compliance RoHS compliant, ELV **Profile** compliant Zero Lead Free Solder Not relevant for lead free

Contact - Rated Current = 5 A

Electrical Characteristics Contact - Rated Current (A) **Termination Features** Hand/Semi-Automatic Insertion Method 🔞 Dimensions Socket Length (mm 2.54 [0.100] [in]) 🔞 Recommended Hole 1.04 [0.041] Size (mm [in]) **Body Features** 0.28 - 0.46 [0.011 -Mating Pin Dia. Range 0.018], 0.406 - 0.533 (mm [in]) 📳 [0.016 - 0.021]Contact Features Contact Plating, Mating Gold Area, Material Contact Plating, Mating Area, Thickness (µm 0.000635 [0.000025] [µin])

Processes ? process RoHS/ELV Compliance Always was RoHS History compliant Conditions for Usage Applies To Printed Circuit Board Operation/Application Application Use Board-to-Device Contact Transmits Signal (Data)/Power (Typical Application) Packaging Features Packaging Method Loose Piece Other Brand AMP

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